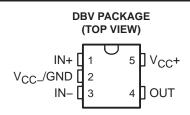
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- Wide Range of Supply Voltages, Single Supply 3 V to 30 V, or Dual Supplies
- Class AB Output Stage
- True Differential-Input Stage
- Low Input Bias Current
- Internal Frequency Compensation
- Short-Circuit Protection



description/ordering information

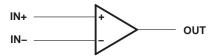
The TL343 is a single operational amplifier similar in performance to the μ A741, but with several distinct advantages. It is designed to operate from a single supply over a range of voltages from 3 V to 30 V. Operation from split supplies also is possible, provided the difference between the two supplies is 3 V to 30 V. The common-mode input range includes the negative supply. Output range is from the negative supply to $V_{CC} - 1.5$ V.

ORDERING INFORMATION

TA	V _{IO} MAX AT 25°C	PACKAG	3E†	ORDERABLE PART NUMBER	TOP-SIDE MARKING‡
4000 to 40500	500 40 1/ 007 00 5 /00		Reel of 3000	TL343IDBVR	T41
-40°C to 125°C	10 mV	SOT-23-5 (DBV)	Reel of 250	TL343IDBVT	T4I_

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

symbol



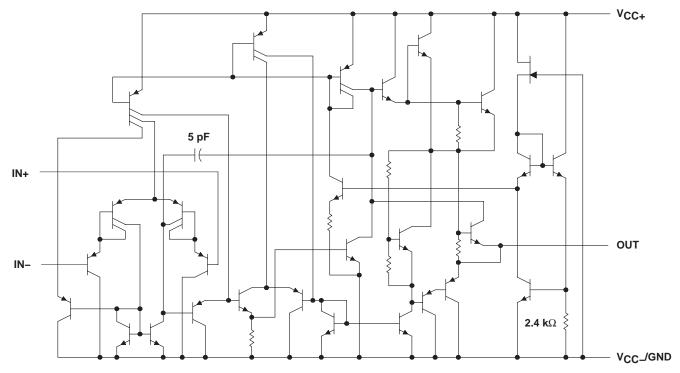


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



[‡]The actual top-side marking has one additional character that designates the assembly/test site.

schematic



NOTE A: Component values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

		MAX	UNIT
Complexed to a contract of	V _{CC+}	18	.,
Supply voltage (see Note 1)	V _{CC} -	-18	V
Supply voltage, V _{CC+} with respect to V _{CC-}		36	V
Differential input voltage (see Note 2)		±36	V
Input voltage (see Notes 1 and 3)		±18	V
Package thermal impedance, θJA (see Notes 4 and 5)		206	°C/W
Operating virtual junction temperature, TJ	_	150	°C
Storage temperature range, T _{stg}		-65 to 150	°C

- NOTES: 1. These voltage values are with respect to the midpoint between V_{CC+} and V_{CC-}.
 - 2. Differential voltages are at IN+ with respect to IN-.

 - Neither input must ever be more positive than V_{CC+} or more negative than V_{CC-}.
 Maximum power dissipation is a function of T_J(max), θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is P_D = (T_J(max) T_A)/θ_{JA}. Selecting the maximum of 150°C can affect reliability.
 - 5. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions

		MIN	MAX	UNIT
Vcc	Single-supply voltage	3	30	V
VCC+	Dual averale valtage	1.5	15	V
VCC-	Dual-supply voltage	-1.5	-15	V
TA	Operating free-air temperature	-40	125	°C

electrical characteristics at specified free-air temperature, $V_{CC\pm}$ = ± 15 V (unless otherwise noted)

PARAMETER		TE	ST CONDITIONS		MIN	TYP	MAX	UNIT
	land effect well-ma	One Nata O		25°C		2	10	>/
VIO	Input offset voltage	See Note 6	See Note o				12	mV
$\alpha_{V_{IO}}$	Temperature coefficient of input offset voltage	See Note 6		Full range		10		μV/°C
	land effect comment	One Nata O		25°C		30	50	
lio	Input offset current	See Note 6		Full range			200	nA
$\alpha_{I_{IO}}$	Temperature coefficient of input offset current	See Note 6		Full range		50		pA/°C
1	lanut higa gurrant	Con Note C		25°C		-200	-500	~ ^
IΒ	Input bias current	See Note 6	Full range			-800	nA	
VICR	Common-mode input voltage range [‡]			25°C	V _{CC} - to 13	V _{CC} - to 13.5		V
		R _L = 10 kΩ	25°C	±12	±13.5			
Vом	Peak output-voltage swing	R _L = 2 kΩ		25°C	±10	±13		V
				Full range	±10			
Δ	Large-signal differential	$V_O = \pm 10 \text{ V}, \qquad R_L = 2 \text{ k}\Omega$		25°C	20	200		\//\/
AVD	voltage amplification			Full range	15			V/mV
ВОМ	Maximum-output-swing bandwidth	V _{OPP} = 20 V, THD ≤ 5%,	$A_{VD} = 1$, $R_L = 2 k\Omega$	25°C		9		kHz
B ₁	Unity-gain bandwidth	$V_O = 50 \text{ mV},$	$R_L = 10 \text{ k}\Omega$	25°C		1		MHz
φm	Phase margin	C _L = 200 pF,	$R_L = 2 k\Omega$	25°C		44		Deg
rį	Input resistance	f = 20 Hz		25°C	0.3	1		$M\Omega$
r _O	Output resistance	f = 20 Hz		25°C		75		Ω
CMRR	Common-mode rejection ratio	V _{IC} = V _{ICR} (min	n)	25°C	70	90		dB
ksvs	Supply-voltage sensitivity ($\Delta V_{IO}/\Delta V_{CC}$)	$V_{CC\pm} = \pm 2.5 \text{ to}$	±15 V	25°C		30	150	μV/V
los	Short-circuit output current§			25°C	±10	±30	±55	mA
Icc	Total supply current	No load,	See Note 6	25°C		0.7	2.8	mA

[†] All characteristics are measured under open-loop conditions, with zero common-mode voltage, unless otherwise specified. Full range for T_A is -40°C to 125°C.

NOTE 6: V_{IO} , I_{IO} , I_{IB} , and I_{CC} are defined at $V_{O} = 0$.



 $[\]ddagger$ The V_{ICR} limits are linked directly, volt-for-volt, to supply voltage; the positive limit is 2 V less than V_{CC+}.

[§] Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.

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electrical characteristics, V_{CC+} = 3 V and 5 V, V_{CC-} = 0 V, T_A = 25°C (unless otherwise noted)

	PARAMETER	TEST CONDITIONS [†]	MIN	TYP	MAX	UNIT
VIO	Input offset voltage	V _O = 1.5 V and 2.5 V		2	10	mV
IIO	Input offset current	V _O = 1.5 V and 2.5 V		30	50	nA
I _{IB}	Input bias current	V _O = 1.5 V and 2.5 V		-200	-500	nA
VOM	Peak output voltage swing‡	$R_L = 10 \text{ k}\Omega$	3.3	3.5		V
AVD	Large-signal differential voltage amplification	$V_O = 1.7 \text{ V to } 3.3 \text{ V}, \qquad R_L = 2 \text{ k}\Omega$	20	200		V/mV
ksvs	Supply-voltage sensitivity ($\Delta V_{IO}/\Delta V_{CC\pm}$)	$V_{CC\pm} = \pm 2.5 \text{ V to } \pm 15 \text{ V}$			150	μV/V
ICC	Supply current	V _O = 1.5 V and 2.5 V, No load		0.7	1.75	mA

[†] All characteristics are measured under open-loop conditions, with zero common-mode input voltage, unless otherwise specified.

operating characteristics, $V_{CC\pm}$ = ± 15 V, T_A = 25°C, A_{VD} = 1 (unless otherwise noted)

	PARAMETER		TYP	UNIT			
SR	Slew rate at unity gain	$V_{I} = \pm 10 \text{ V},$	C _L = 100 pF,	$R_L = 2 k\Omega$,	See Figure 1	1	V/μs
t _r	Rise time	$\Delta V_{O} = 50 \text{ mV},$	$C_L = 100 pF$,	$R_L = 10 \text{ k}\Omega$,	See Figure 1	0.35	μs
t _f	Fall time	$\Delta V_{O} = 50 \text{ mV},$	$C_L = 100 pF$,	$R_L = 10 \text{ k}\Omega$,	See Figure 1	0.35	μs
	Overshoot factor	$\Delta V_O = 50 \text{ mV},$	C _L = 100 pF,	$R_L = 10 \text{ k}\Omega$,	See Figure 1	20%	
	Crossover distortion	$V_{I(PP)} = 30 \text{ mV},$	V _{OPP} = 2 V,	f = 10 kHz		1%	

PARAMETER MEASUREMENT INFORMATION

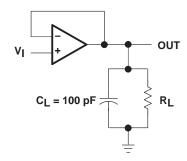
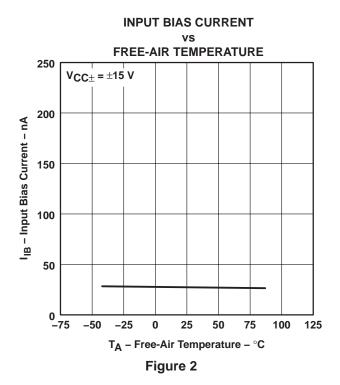
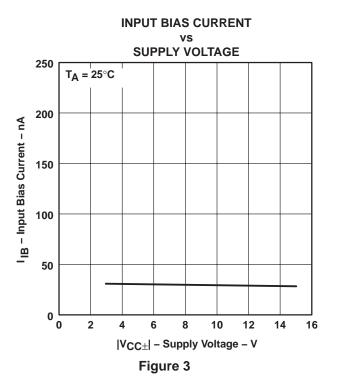


Figure 1. Unity-Gain Amplifier

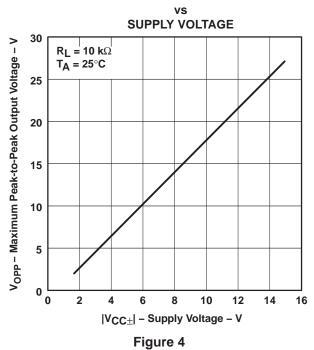
[‡] Output swings essentially to ground.

TYPICAL CHARACTERISTICS[†]

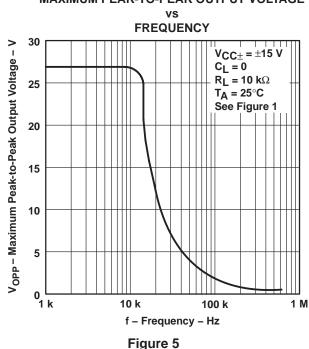




MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE



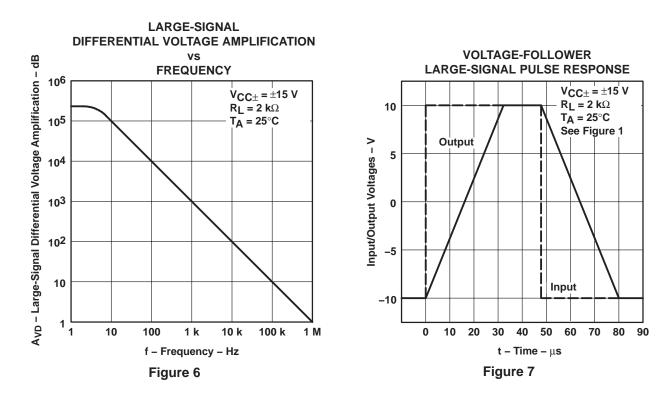
MAXIMUM PEAK-TO-PEAK OUTPUT VOLTAGE



[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.



TYPICAL CHARACTERISTICS[†]



[†] Operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied.



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PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TL343IDBVR	ACTIVE	SOT-23	DBV	5	3000	RoHS & Green	NIPDAU SN	Level-1-260C-UNLIM	-40 to 125	(T4IG, T4IJ, T4IL, T4IS)	Samples
TL343IDBVT	LIFEBUY	SOT-23	DBV	5	250	RoHS & Green	NIPDAU SN	Level-1-260C-UNLIM	-40 to 125	(T4IG, T4IJ, T4IL, T4IU)	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

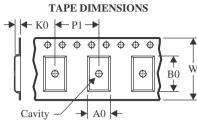
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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

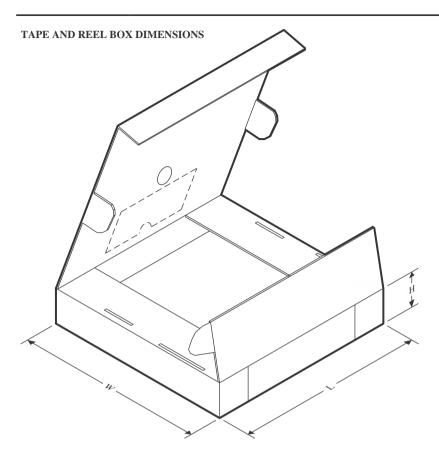
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL343IDBVR	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TL343IDBVR	SOT-23	DBV	5	3000	180.0	8.4	3.23	3.17	1.37	4.0	8.0	Q3
TL343IDBVT	SOT-23	DBV	5	250	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TL343IDBVT	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3

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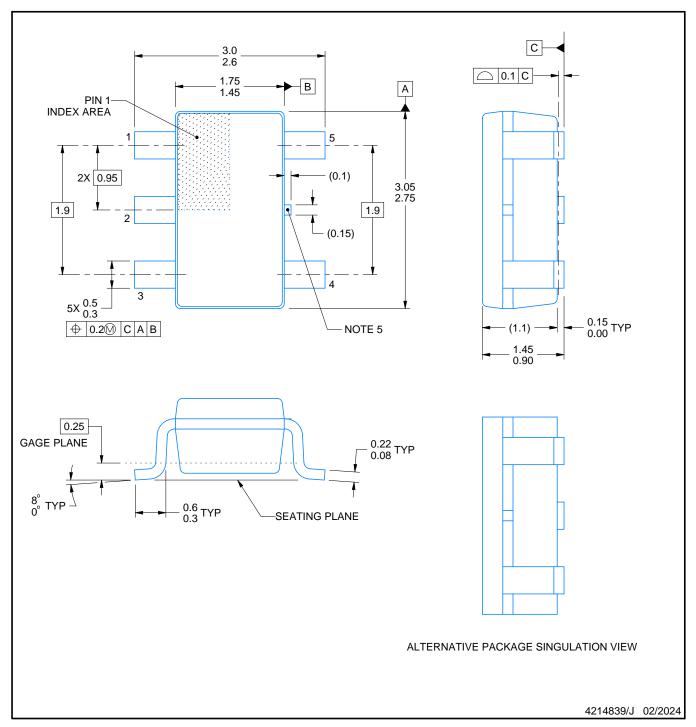


*All dimensions are nominal

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Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL343IDBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TL343IDBVR	SOT-23	DBV	5	3000	202.0	201.0	28.0
TL343IDBVT	SOT-23	DBV	5	250	203.0	203.0	35.0
TL343IDBVT	SOT-23	DBV	5	250	180.0	180.0	18.0



SMALL OUTLINE TRANSISTOR



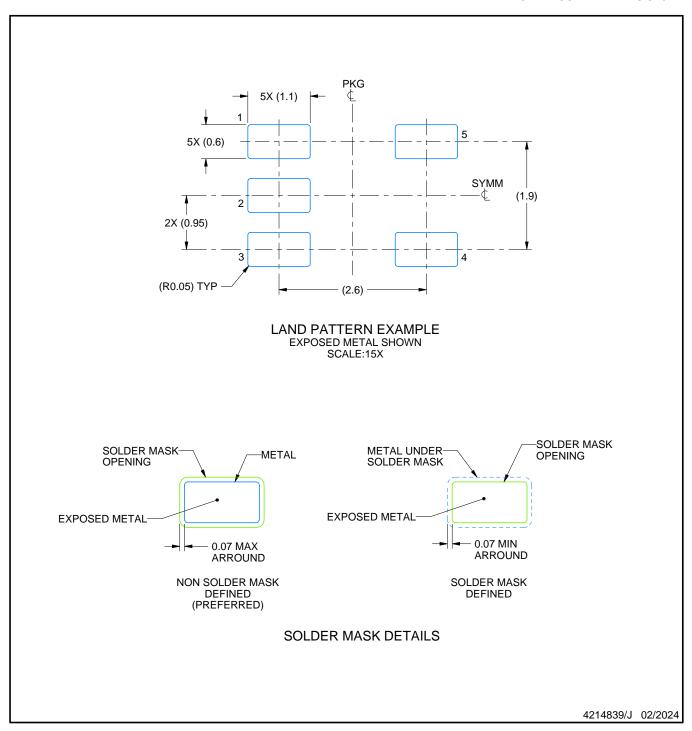
NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
 3. Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.



SMALL OUTLINE TRANSISTOR



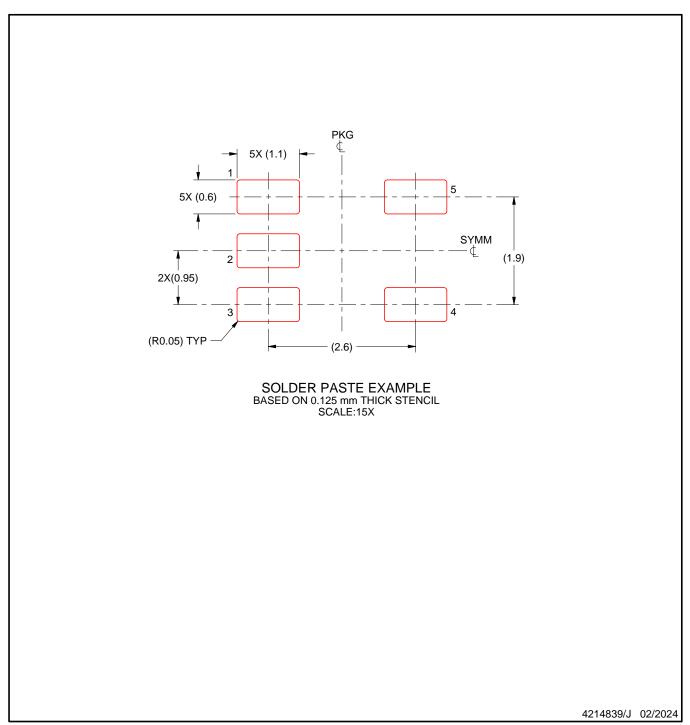
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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